CMOS Digital Integrated Circuits Silicon Monolithic

# 74HC4051D,74HC4052D

#### 1. Functional Description

74HC4051D:8-Channel Analog Multiplexer/Demultiplexer 74HC4052D:Dual 4-Channel Analog Multiplexer/Demultiplexer

#### 2. General

The 74HC4051D, 74HC4052D are high speed CMOS ANALOG MULTIPLEXER/DEMULTIPLEXER fabricated with silicon gate C2MOS technology. They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The 74HC4051D has an 8 channel configuration and the 74HC4052D has a 4 channel  $\times$  2 configuration.

The digital signal to the control terminal turns "ON" the corresponding switch of each channel a large amplitude signal ( $V_{CC}$  -  $V_{EE}$ ) can then be switched by the small logical amplitude ( $V_{CC}$  - GND) control signal.

For example, in the case of  $V_{\rm CC}$  = 5 V, GND = 0 V,  $V_{\rm EE}$  = -5 V, signals between -5 V and +5 V can be switched from the logical circuit with a single power supply of 5 V. As the ON-resistance of each switch is low, they can be connected to circuits with low input impedance.

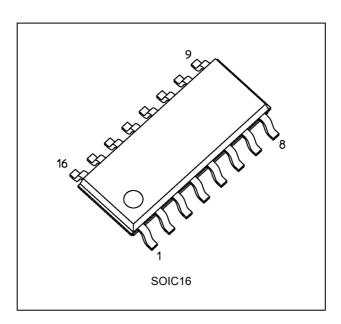
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### 3. Features

- (1) Wide operating temperature range:  $T_{opr} = -40$  to 125 °C (Note 1)
- (2) Low power dissipation:  $I_{CC}$  = 4.0  $\mu A$  (max) ( $V_{CC}$  = 6.0 V,  $V_{EE}$  = GND,  $T_a$  = 25  $^{\circ}$ C)
- (3) Low ON-resistance:  $R_{ON} = 50 \Omega$  (typ.) at  $V_{CC}$   $V_{EE} = 9 V$
- (4) High degree of linearity: THD = 0.02 % (typ.) at  $V_{CC}$   $V_{EE}$  = 9 V

Note 1: Operating Range spec of  $T_{opr}$  = -40 °C to 125 °C is applicable only for the products which manufactured after July 2020.

#### 4. Packaging

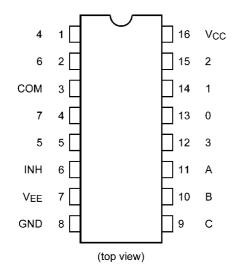


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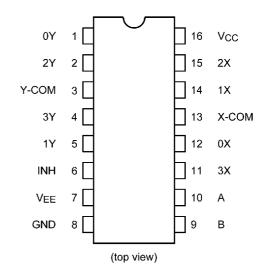
Start of commercial production

## 5. Pin Assignment



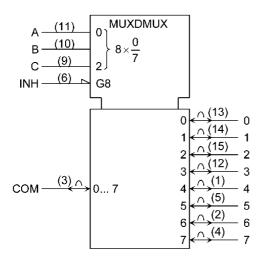


#### 74HC4052D

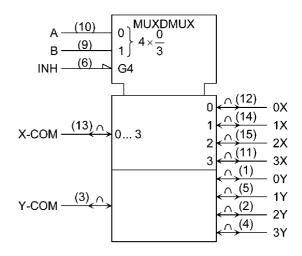


## 6. IEC Logic Symbol

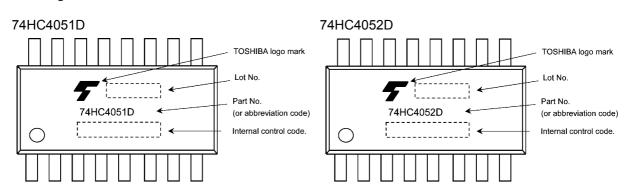
74HC4051D



#### 74HC4052D



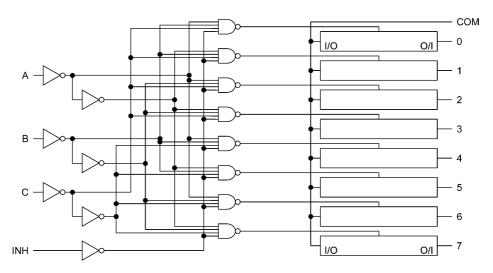
#### 7. Marking



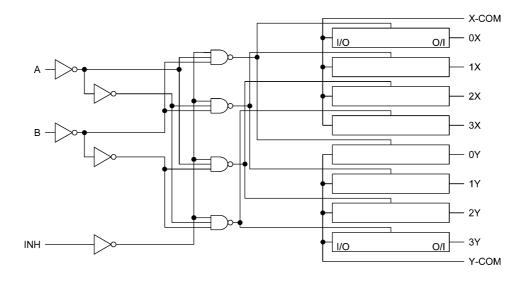
Rev.5.0

## 8. System Diagram

#### 74HC4051D



#### 74HC4052D



Rev.5.0

#### 9. Truth Table

Input Inhibit	Input C*	Input B	Input A	ON Channel 74HC4051D	ON Channel 74HC4052D
L	L	L	L	0	0X, 0Y
L	L	L	Н	1	1X, 1Y
L	L	Н	L	2	2X, 2Y
L	L	Н	Н	3	3X, 3Y
L	Н	L	L	4	_
L	Н	L	Н	5	_
L	Н	Н	L	6	_
L	Н	Н	Н	7	_
Н	Х	Х	Х	None	None

X: Don't care

\*: Except 74HC4052D

#### 10. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V <sub>CC</sub>		-0.5 to 7.0	V
Supply voltage	V <sub>EE</sub>		-7.0 to 0	V
Supply voltage	V <sub>CC</sub> -V <sub>EE</sub>		-0.5 to 13.0	V
Input voltage	V <sub>IN</sub>		-0.5 to V <sub>CC</sub> + 0.5	V
Switch I/O voltage	V <sub>I/O</sub>		V <sub>EE</sub> - 0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>		±20	mA
I/O diode current	I <sub>I/OK</sub>		±20	mA
Switch through current	I <sub>T</sub>		±25	mA
V <sub>CC</sub> /ground current	I <sub>CC</sub>		±50	mA
Power dissipation	P <sub>D</sub>	(Note 1)	500	mW
Storage temperature	T <sub>stg</sub>		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: P<sub>D</sub> derates linearly with -8 mW/°C above 85 °C.

#### 11. Operating Ranges (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V <sub>CC</sub>		2.0 to 6.0	V
Supply voltage	$V_{EE}$		-6.0 to 0	V
Supply voltage	$V_{CC}$ - $V_{EE}$		2.0 to 12.0	V
Input voltage	V <sub>IN</sub>		0 to V <sub>CC</sub>	V
Switch I/O voltage	V <sub>I/O</sub>		$V_{\sf EE}$ to $V_{\sf CC}$	V
Operating temperature	T <sub>opr</sub>	(Note 1)	-40 to 125	°C
Input rise and fall times	t <sub>r</sub> ,t <sub>f</sub>		0 to 50	μS

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either V<sub>CC</sub> or GND.

Note 1: Operating Range spec of  $T_{opr}$  = -40 °C to 125 °C is applicable only for the products which manufactured after July 2020.

## 12. Electrical Characteristics

# 12.1. DC Characteristics (Unless otherwise specified, $T_a = 25$ °C)

		I						
Characteristics	Symbol	Test Condition	V <sub>EE</sub> (V)	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
High-level input voltage	V <sub>IH</sub>	_		2.0	1.50	_	_	V
				4.5	3.15	_	_	
				6.0	4.20	_	_	
Low-level input voltage	V <sub>IL</sub>	_		2.0	_	_	0.50	V
				4.5	_	_	1.35	
				6.0	_	_	1.80	
ON-resistance	R <sub>ON</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$	GND	4.5	_	180	240	Ω
		$V_{I/O} = V_{CC}$ to $V_{EE}$ $I_{I/O} \le 2 \text{ mA}$	-4.5	4.5	_	140	190	
		11/0 = <b>2</b> 11/A	-6.0	6.0	_	135	180	
		$\begin{aligned} &V_{IN} = V_{IH} \text{ or } V_{IL} \\ &V_{I/O} = V_{EE} \\ &I_{I/O} \leq 2 \text{ mA} \end{aligned}$	GND	2.0	_	210	_	
			GND	4.5	_	150	200	
			-4.5	4.5	_	130	170	
			-6.0	6.0	_	125	170	
		$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{I/O} = V_{CC}$	GND	2.0	_	220	_	
			GND	4.5	_	95	130	
		I <sub>I/O</sub> ≤ 2 mA	-4.5	4.5	_	75	100	
			-6.0	6.0	_	70	100	
Difference of ON-resistance	$\Delta R_{ON}$	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	GND	4.5	_	10	30	Ω
between switches		$V_{I/O} = V_{CC}$ to $V_{EE}$ $I_{I/O} \le 2$ mA	-4.5	4.5	_	5	12	
		11/0 \( \sum 2 \) 11/A	-6.0	6.0	_	5	10	
Input/Output leakage current	I <sub>OFF</sub>	V <sub>OS</sub> = V <sub>CC</sub> or GND	GND	6.0	_	_	±0.06	μА
(Switch OFF)		$V_{IS}$ = GND or $V_{CC}$ $V_{IN}$ = $V_{IH}$ or $V_{IL}$	-6.0	6.0	_	_	±0.1	
Input/Output leakage current	I <sub>I/O</sub>	V <sub>OS</sub> = V <sub>CC</sub> or GND	GND	6.0	_	_	±0.06	μА
(Switch ON)		$V_{IN} = V_{IH}$ or $V_{IL}$	-6.0	6.0	_	_	±0.1	
Control input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND	GND	6.0	_	_	±0.1	μА
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND	GND	6.0	_	_	4.0	μА
			-6.0	6.0	_	_	8.0	

# 12.2. DC Characteristics (Unless otherwise specified, $T_a$ = -40 to 85 °C)

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Characteristics	Symbol	Test Condition	V <sub>EE</sub> (V)	V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	$V_{IH}$	_		2.0	1.50	_	\ \ \
				4.5	3.15	_	
				6.0	4.20	_	
Low-level input voltage	$V_{IL}$	_		2.0	_	0.50	V
				4.5		1.35	
				6.0		1.80	
ON-resistance	R <sub>ON</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	GND	4.5		300	Ω
		$V_{I/O} = V_{CC}$ to $V_{EE}$ $I_{I/O} \le 2 \text{ mA}$	-4.5	4.5	_	240	
		11/0 = 2 11/A	-6.0	6.0		225	
		$V_{IN} = V_{IH} \text{ or } V_{IL}$	GND	4.5		250	
		$V_{I/O} = V_{EE}$ $I_{I/O} \le 2 \text{ mA}$	-4.5	4.5		215	
		/0 ≥ 2      A	-6.0	6.0	_	215	]
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	GND 4.5 —	_	165		
		$V_{I/O} = V_{CC}$ $I_{I/O} \le 2 \text{ mA}$	-4.5	4.5	_	125	
		/0 ≥ 2      A	-6.0	6.0	_	125	]
Difference of ON-resistance	$\Delta R_{ON}$	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	GND	4.5	_	35	Ω
between switches		$V_{I/O} = V_{CC}$ to $V_{EE}$ $I_{I/O} \le 2 \text{ mA}$	-4.5	4.5	_	15	
		/0 ≥ 2      A	-6.0	6.0	_	12	]
Input/Output leakage current	I <sub>OFF</sub>	V <sub>OS</sub> = V <sub>CC</sub> or GND	GND	6.0	_	±0.6	μА
(Switch OFF)		$V_{IS}$ = GND or $V_{CC}$ $V_{IN}$ = $V_{IH}$ or $V_{IL}$	-6.0	6.0	_	±1.0	
Input/Output leakage current	I <sub>I/O</sub>	V <sub>OS</sub> = V <sub>CC</sub> or GND	GND	6.0		±0.6	μА
(Switch ON)		$V_{IN} = V_{IH} \text{ or } V_{IL}$	-6.0	6.0	_	±1.0	μА
Control input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND	GND	6.0	_	±1.0	μА
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND	GND	6.0	_	40.0	μА
			-6.0	6.0	_	80.0	

# 12.3. DC Characteristics (Note) (Unless otherwise specified, T<sub>a</sub> = -40 to 125 °C)

Characteristics	Symbol	Test Condition	V <sub>EE</sub> (V)	V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	V <sub>IH</sub>	_		2.0	1.50	_	V
				4.5	3.15	_	
				6.0	4.20	_	
Low-level input voltage	V <sub>IL</sub>	_		2.0	_	0.50	V
				4.5		1.35	
				6.0		1.80	
ON-resistance	R <sub>ON</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	GND	4.5		340	Ω
		$V_{I/O} = V_{CC}$ to $V_{EE}$ $I_{I/O} \le 2 \text{ mA}$	-4.5	4.5	_	275	
		11/0 = 2 11/A	-6.0	6.0		255	
		$V_{IN} = V_{IH} \text{ or } V_{IL}$	GND	4.5		285	
		$V_{I/O} = V_{EE}$ $I_{I/O} \le 2 \text{ mA}$	-4.5	4.5		245	
		11/0 ≤ 2 11/A	-6.0	6.0		245	
		$V_{IN} = V_{IH} \text{ or } V_{IL}$	GND	4.5		190	
		$V_{I/O} = V_{CC}$ $I_{I/O} \le 2 \text{ mA}$	-4.5	4.5			
		11/0 = 2 111A	-6.0	6.0	_	145	
Difference of ON-resistance	$\Delta R_{ON}$	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	GND	4.5		35	Ω
between switches		$V_{I/O} = V_{CC}$ to $V_{EE}$ $I_{I/O} \le 2 \text{ mA}$	-4.5	4.5		15	
		11/0 = 2 11/A	-6.0	6.0		12	
Input/Output leakage current	I <sub>OFF</sub>	$V_{OS} = V_{CC}$ or GND	GND	6.0		±3.0	μΑ
(Switch OFF)		$V_{IS}$ = GND or $V_{CC}$ $V_{IN}$ = $V_{IL}$	-6.0	6.0	_	±5.0	
Input/Output leakage current	I <sub>I/O</sub>	V <sub>OS</sub> = V <sub>CC</sub> or GND	GND	6.0		±3.0	μА
(Switch ON)		$V_{IN} = V_{IH}$ or $V_{IL}$	-6.0	6.0	_	±5.0	
Control input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND	GND	6.0	_	±1.0	μА
Quiescent supply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND	GND	6.0		80.0	μА
			-6.0	6.0	_	160.0	

Note: Operating Range spec of T<sub>opr</sub> = -40 °C to 125 °C is applicable only for the products which manufactured after July 2020.

# 12.4. AC Characteristics (Unless otherwise specified, $C_L = 50$ pF, $T_a = 25$ °C, Input: $t_r = t_f = 6$ ns)

Characteristics	Part Number	Symbol	Test Condition	V <sub>EE</sub> (V)	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit	
Phase difference		ΦΙ/Ο	_	GND	2.0	_	18	25	ns	
between input to output				GND	4.5	_	7	12		
				GND	6.0	_	6	10		
				-4.5	4.5	_	5	8		
Output enable time	74HC4051D	t <sub>PZL</sub> ,t <sub>PZH</sub>	$R_L = 1 k\Omega$	GND	2.0	_	90	145	ns	
			Figure 1	GND	4.5	_	30	45		
				GND	6.0	_	25	35		
				-4.5	4.5	_	24	34		
	74HC4052D		$R_L = 1 k\Omega$	GND	2.0	_	90	145		
			Figure 1	GND	4.5	_	30	45		
				GND	6.0	_	25	35		
				-4.5	4.5	_	24	34		
Output disable time	74HC4051D	$t_{PLZ}, t_{PHZ}$	$R_L = 1 k\Omega$	GND	2.0	_	56	85	ns	
			Figure 1	GND	4.5	_	26	35		
				GND	6.0	_	25	33		
		R <sub>L</sub> = 1 kΩ			-4.5	4.5	_	24	32	
	74HC4052D		GND	2.0	_	56	85			
			Figure 1	GND	4.5	_	26	35		
				GND	6.0	_	25	33		
				-4.5	4.5	_	24	32		
Control input capacitance		C <sub>IN</sub>	_	_	_	_	5	10	pF	
Common terminal	74HC4051D	C <sub>IS</sub>	Figure 2	-5.0	5.0	_	36	70	pF	
capacitance	74HC4052D					_	19	40		
Switch terminal	74HC4051D	Cos	Figure 2	-5.0	5.0	_	7	15	pF	
capacitance	74HC4052D					_	7	15		
Feedthrough	74HC4051D	C <sub>IOS</sub>	Figure 2	-5.0	5.0	_	0.95	2	pF	
capacitance	74HC4052D					_	0.85	2		
Power dissipation	74HC4051D	C <sub>PD</sub>	Figure 2	-5.0	5.0	_	11		pF	
capacitance	74HC4052D		(Note 1)				19			

Note 1:  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.  $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{|N} + I_{CC}$ 

# 12.5. AC Characteristics (Unless otherwise specified, $C_L$ = 50 pF, $T_a$ = -40 to 85 °C, Input: $t_r$ = $t_f$ = 6 ns)

Characteristics	Part Number	Symbol	Test Condition	V <sub>EE</sub> (V)	V <sub>CC</sub> (V)	Min	Max	Unit
Phase difference between		Ψι/Ο	_	GND	2.0	_	30	ns
input to output				GND	4.5	_	15	
				GND	6.0	_	13	]
				-4.5	4.5	_	10	1
Output enable time	74HC4051D	$t_{PZL}, t_{PZH}$	$R_L = 1 k\Omega$	GND	2.0	_	150	ns
			Figure 1	GND	4.5	_	55	]
				GND	6.0	_	42	
				-4.5	4.5	_	41	
	74HC4052D		$R_L = 1 k\Omega$ Figure 1	GND	2.0	_	150	
				GND	4.5	_	55	
				GND	6.0	_	42	
				-4.5	4.5	_	41	]
Output disable time	74HC4051D	t <sub>PLZ</sub> ,t <sub>PHZ</sub>		GND	2.0	_	90	ns
			Figure 1	GND	4.5	_	45	
				GND	6.0	_	40	]
				-4.5	4.5	_	39	
	74HC4052D		$R_L = 1 k\Omega$	GND	2.0	_	90	
			Figure 1	GND	4.5	_	45	
				GND	6.0	_	40	
				-4.5	4.5	_	39	
Control input capacitance		C <sub>IN</sub>	_	_	_	_	10	pF
Common terminal	74HC4051D	C <sub>IS</sub>	Figure 2	-5.0	5.0	_	70	pF
capacitance	74HC4052D					_	40	
Switch terminal capacitance	74HC4051D	Cos	Figure 2	-5.0	5.0	_	15	pF
	74HC4052D					_	15	
Feedthrough capacitance	74HC4051D	C <sub>IOS</sub>	Figure 2	-5.0	5.0	_	2	pF
	74HC4052D					_	2	

12.6. AC Characteristics (Note) (Unless otherwise specified,  $C_L = 50$  pF,  $T_a = -40$  to 125 °C, Input:  $t_r = t_f = 6$  ns)

Characteristics	Part Number	Symbol	Test Condition	V <sub>EE</sub> (V)	V <sub>CC</sub> (V)	Min	Max	Unit	
Phase difference between		Ψι/Ο	_	GND	2.0	_	35	ns	
input to output				GND	4.5	_	17		
				GND	6.0		15		
				-4.5	4.5		12		
Output enable time	74HC4051D	$t_{PZL}, t_{PZH}$	$R_L = 1 k\Omega$	GND	2.0		155	ns	
			Figure 1	GND	4.5		62		
				GND	6.0		47		
				-4.5	4.5		46		
	74HC4052D		$R_L = 1 k\Omega$	GND	2.0		155		
			Figure 1	GND	4.5		62		
				GND	6.0		47		
				-4.5	4.5	_	46		
Output disable time	74HC4051D	$t_{PLZ}, t_{PHZ}$	$R_L = 1 k\Omega$	GND	2.0	_	95	ns	
			Figure 1	GND	4.5		52		
				GND	6.0	_	45		
				-4.5	4.5		44		
	74HC4052D			$R_L = 1 k\Omega$	GND	2.0		95	
			Figure 1	GND	4.5		52		
				GND	6.0		45		
				-4.5	4.5		44		
Control input capacitance		C <sub>IN</sub>	_	_	_	_	10	pF	
Common terminal	74HC4051D	C <sub>IS</sub>	Figure 2	-5.0	5.0		70	pF	
capacitance	74HC4052D			-5.0	5.0		40		
Switch terminal capacitance	74HC4051D	C <sub>OS</sub>	Figure 2	-5.0	5.0		15	pF	
	74HC4052D	Cos	]	-5.0	5.0		15		
Feedthrough capacitance	74HC4051D	C <sub>IOS</sub>	Figure 2	-5.0	5.0	_	2	pF	
	74HC4052D			-5.0	5.0	_	2		

Note: Operating Range spec of  $T_{opr}$  = -40 °C to 125 °C is applicable only for the products which manufactured after July 2020.

# 12.7. Analog Switch Characteristics (T<sub>a</sub> = 25 °C) (Note)

Characteristics	Part Number	Symbol	Test Condition		V <sub>EE</sub> (V)	V <sub>CC</sub> (V)	Тур.	Unit
Sine Wave Distortion		THD	$R_L$ = 10 kΩ, $C_L$ = 50 pF	$V_{IN} = 4.0 V_{p-p}$	-2.25	2.25	0.025	%
			f <sub>IN</sub> = 1 kHz	$V_{IN} = 8.0 V_{p-p}$	-4.5	4.5	0.020	
				$V_{IN} = 11.0 V_{p-p}$	-6.0	6.0	0.018	
Maximum frequency		f <sub>MAX(I/O)</sub>	Adjust f <sub>IN</sub> voltage to obtain	(Note 1)	-2.25	2.25	120	MHz
response	74HC4051D		0 dBm at V <sub>OS</sub>	(Note 2)			45	
	74HC4052D						70	
				(Note 1)	-4.5	4.5	190	
	74HC4051D		f <sub>IN</sub> = 1 MHz, sine wave Figure 3	(Note 2)			70	
	74HC4052D		940 0				110	
				(Note 1)	-6.0	6.0	200	
	74HC4051D			(Note 2)			85	
	74HC4052D						140	
Feed through attenuation (switch OFF)		FTH	V <sub>IN</sub> is centered at (V <sub>CC</sub> /2). Adjust input for 0 dBm.		-2.25	2.25	-50	dB
attenuation (switch Or i )			$R_L = 600 \Omega$ , $C_L = 50 pF$ ,		-4.5	4.5	-50	
			f <sub>IN</sub> = 1 MHz, sine wave Figure 4		-6.0	6.0	-50	
Crosstalk (control input		X <sub>talk</sub>	$R_L = 600 \Omega$ , $C_L = 50 pF$ ,		-2.25	2.25	60	mV
to signal output)			$f_{IN} = 1 \text{ MHz},$ square wave ( $t_r = t_f = 6 \text{ ns}$ )		-4.5	4.5	140	
			Figure 5		-6.0	6.0	200	
Crosstalk (between any switches)		X <sub>talk</sub>	Adjust V <sub>IN</sub> to obtain 0 dBm		-2.25	2.25	-50	dB
Switches)			at input. $R_L = 600 \Omega$ , $C_L = 50 pF$ ,		-4.5	4.5	-50	
			f <sub>IN</sub> = 1 MHz, sine wave Figure 6		-6.0	6.0	-50	

Note: These characteristics are determined by design of devices. Note 1: Input COMMON terminal, and measured at SWITCH terminal.

Note 2: Input SWITCH terminal, and measured at COMMON terminal.

#### 13. AC Test Circuit

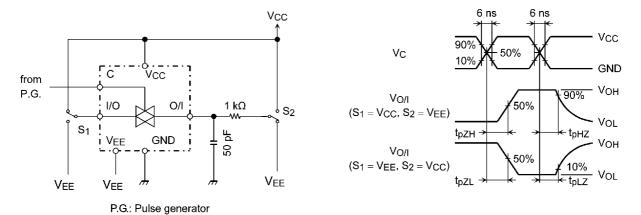


Figure 1 t<sub>PLZ</sub>, t<sub>PHZ</sub>, t<sub>PZL</sub>, t<sub>PZH</sub>

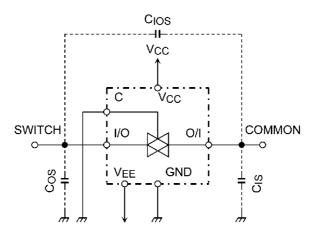


Figure 2 C<sub>IOS</sub>, C<sub>IS</sub>, C<sub>OS</sub>

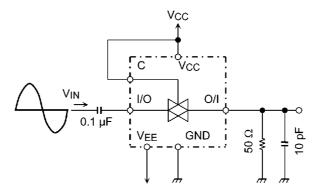


Figure 3 Frequency Response

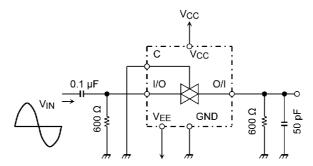
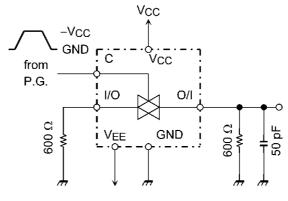


Figure 4 Feedthrough Attenuation



P.G.: Pulse generator

Figure 5 Cross Talk (control input to output signal)

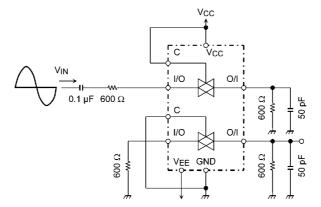
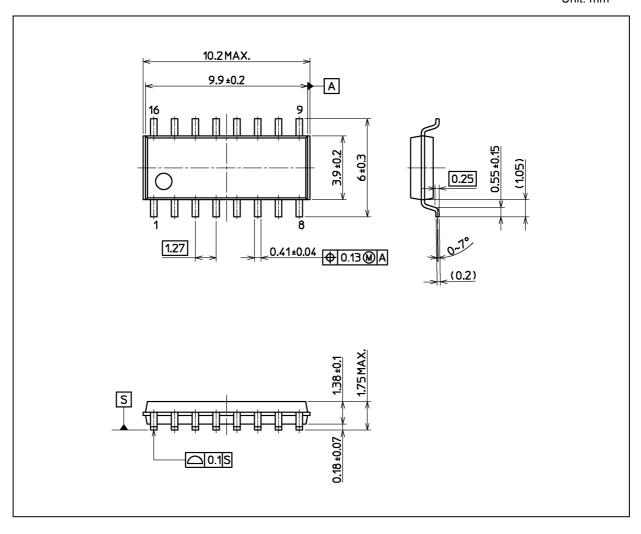


Figure 6 Cross Talk (between any two switches)

## **Package Dimensions**

Unit: mm



Weight: 0.15 g (typ.)

	Package Name(s)
Nickname: SOIC16	

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